

**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Albert Chan  
Serial No.: 10/663,207  
Filed: September 15, 2003  
For: THERMAL INTERFACE ADHESIVE  
Art Group Unit: 2835  
Examiner: Unknown  
Atty. Dkt.: 02EK-105601

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(37 C.F.R. § 1.10)**

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Jordan Wilson

**INFORMATION DISCLOSURE STATEMENT  
PURSUANT TO 37 C.F.R. §1.56 AND §§1.97-1.98**

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Sir:

The citations listed on the enclosed PTO-1449 Form are submitted under 37 C.F.R. §§1.97 and 1.98, and in compliance with the duty of disclosure as defined in 37 C.F.R. §1.56. The Examiner is requested to make these citations officially of record in the application. This Information Disclosure Statement is being submitted before the mailing of a first Office Action. Accordingly, no fee or certification is believed to be required.


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January 30, 2004

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Respectfully submitted,



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FORM PTO-1449 (Modified)

ATTY. DOCKET NO.

SERIAL NO.

02EK-105601

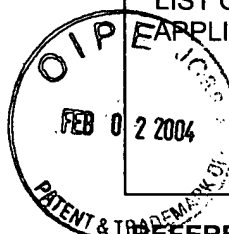
10/663,207

LIST OF PATENTS AND PUBLICATIONS FOR  
APPLICANT(S) INFORMATION DISCLOSURE  
STATEMENT

APPLICANT: Albert Chan

FILING DATE:  
September 15, 2003GROUP ART UNIT:  
2835

(Use several sheets if necessary)



## REFERENCE DESIGNATION

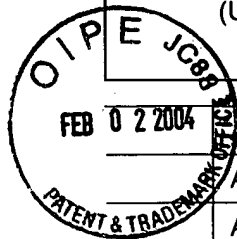
## U.S. PATENT DOCUMENTS

EXAM'R INITIAL		DOCUMENT NUMBER	DATE	NAME	Class	Subclass	Filing Date If Appropriate
	A1	3,915,729	10/28/1975	Eustice			
	A2	4,391,742	07/05/1983	Steigerwald, et al.			
	A3	4,619,715	10/28/1986	Hwang			
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	A8	5,088,189	02/18/1992	Brown			
	A9	5,128,746	07/07/1992	Pennisi, et al.			
	A10	5,150,195	09/22/1992	Nguyen			
	A11	5,156,771	10/20/1992	Yamamoto, et al.			
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	A20	5,640,761	06/24/1997	DiStefano, et al.			
	A21	5,641,996	06/24/1997	Omoya, et al.			
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	A26	5,844,320	12/01/1998	Ono, et al.			

EXAMINER

DATE CONSIDERED

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to Applicant(s).



FORM PTO-1449 (Modified)  LIST OF PATENTS AND PUBLICATIONS FOR APPLICANT(S)' INFORMATION DISCLOSURE STATEMENT  (Use several sheets if necessary)	ATTY. DOCKET NO. <b>02EK-105601</b>	SERIAL NO. <b>10/663,207</b>
	APPLICANT: <b>Albert Chan</b>	
	FILING DATE: <b>September 15, 2003</b>	GROUP ART UNIT: <b>2835</b>

A27	5,851,311	12/22/1998	Diamant, et al.			
A28	5,985,043	11/16/1999	Zhou, et al.			
A29	6,054,761	04/25/2000	McCormack, et al.			
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**FOREIGN PATENT DOCUMENTS**

EXAM'R INITIAL		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	Subclass	TRANSLAT'N	
							yes	no
	B1							
	B2							
	B3							

**OTHER ART (Include Author, Title, Date, Pertinent Pages, Etc.)**

YG	C1	Shell Chemical, "Shell Resins: Heloxy® 505 Modifier," 4 pages, 8/93.
YG	C2	Shell Chemical, "Shell Resins: EPON® Resin 828," 8 pages, 10/96.
YG	C3	Shell Chemical, "Technical Bulletin Shell Chemical Company: EPON® Resin 1120-A-80 and EPON® Resin 1123-A-80," 4 pages, 1/92.
YG	C4	Shell Chemical, "Shell Resins: Heloxy® 62 Modifier," 4 pages, 8/93.
YG	C5	Shell Chemical, "Shell Resins: Heloxy® 67 Modifier," 4 pages, 8/93.
YG	C6	Ishino et al., "Development of Multilayer Wiring Board by Simultaneous Stacking Method of Tape Film" (Journal of Japan Institute of Electronics Packaging), May 1998, vol. 1, No. 2, pp. 124-129.

EXAMINER	DATE CONSIDERED
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